



JIANGSU CHANGJIANG ELECTRONICS TECHNOLOGY CO., LTD

## SOT-323 Plastic-Encapsulate MOSFETs

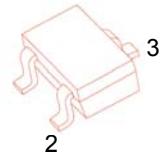
### CJ2101 P-Channel 8-V(D-S) MOSFET

#### FEATURE

Leading Trench Technology for Low  $R_{DS(on)}$  Extending Battery Life

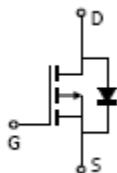
#### SOT-323

1. GATE
2. SOURCE
3. DRAIN



#### APPLICATIONS

- High Side Load Switch
- Charging Circuit
- Single Cell Battery Applications such as Cell Phones, Digital Cameras ,PDAs, etc



#### MARKING: TS1

Maximum ratings ( $T_a=25^\circ\text{C}$  unless otherwise noted)

| Parameter                                    | Symbol          | Value      | Unit                      |
|--|-----------------|------------|---------------------------|
| Drain-Source Voltage                         | $V_{DS}$        | -8.0       | V                         |
| Gate-Source Voltage                          | $V_{GS}$        | $\pm 8.0$  |                           |
| Continuous Drain Current                     | $I_D$           | -1.4       | A                         |
| Pulsed Drain Current ( $t_p=10\mu\text{s}$ ) | $I_{DM}$        | -3.0       |                           |
| Continuous Source-Drain Diode Current        | $I_S$           | -0.46      |                           |
| Power Dissipation                            | $P_D$           | 0.29       | W                         |
| Thermal Resistance from Junction to Ambient  | $R_{\theta JA}$ | 430        | $^\circ\text{C}/\text{W}$ |
| Junction Temperature                         | $T_J$           | 150        | $^\circ\text{C}$          |
| Storage Temperature                          | $T_{stg}$       | -50 ~ +150 |                           |

**Electrical characteristics ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

| Parameter                                      | Symbol              | Test Condition   | Min   | Typ   | Max       | Unit             |
|--|---------------------|--|-------|-------|-----------|------------------|
| <b>OFF CHARACTERISTICS</b>                     |                     |  |       |       |           |                  |
| Drain-Source Breakdown Voltage                 | $V_{DSS}$           | $V_{GS} = 0V, I_D = -250\mu\text{A}$                           | -8.0  | -20   |           | V                |
| Gate-Source Leakage                            | $I_{GSS}$           | $V_{DS} = 0V, V_{GS} = \pm 8V$                                 |       |       | $\pm 100$ | nA               |
| Zero Gate Voltage Drain Current                | $I_{DSS}$           | $V_{DS} = -6.4V, V_{GS} = 0V$                                  |       |       | -1.0      | $\mu\text{A}$    |
| <b>OFF CHARACTERISTICS (note 1)</b>            |                     |  |       |       |           |                  |
| Gate-Source Threshold Voltage                  | $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}, I_D = -250\mu\text{A}$                       | -0.45 | -0.7  |           | V                |
| Drain-Source On-State Resistance               | $R_{DS(on)}$        | $V_{GS} = -4.5V, I_D = -1.0A$                                  |       |       | 100       | $\text{m}\Omega$ |
|  |                     | $V_{GS} = -2.5V, I_D = -0.5A$                                  |       |       | 140       |                  |
|  |                     | $V_{GS} = -1.8V, I_D = -0.3A$                                  |       |       | 210       |                  |
| <b>CHARGES AND CAPACITANCES (note 3)</b>       |                     |  |       |       |           |                  |
| Input Capacitance                              | $C_{iss}$           | $V_{DS} = -8.0V, V_{GS} = 0V, f = 1\text{MHz}$                 |       | 640   |           | $\text{pF}$      |
| Output Capacitance                             | $C_{oss}$           |  |       | 120   |           |                  |
| Reverse Transfer Capacitance                   | $C_{rss}$           |  |       | 82    |           |                  |
| <b>SWITCHING CHARACTERISTICS (note 2,3)</b>    |                     |  |       |       |           |                  |
| Turn-On Delay Time                             | $t_{d(on)}$         | $V_{GS} = -4.5V, V_{DD} = -4.0V, I_D = -1.0A, R_G = 6.2\Omega$ |       | 6.2   |           | $\text{ns}$      |
| Rise Time                                      | $t_r$               |  |       | 15    |           |                  |
| Turn-Off Delay Time                            | $t_{d(off)}$        |  |       | 26    |           |                  |
| Fall Time                                      | $t_f$               |  |       | 18    |           |                  |
| <b>Drain-source Body diode characteristics</b> |                     |  |       |       |           |                  |
| Forward Diode Voltage                          | $V_{SD}$            | $V_{GS} = 0V, I_S = -0.3A$                                     |       | -0.62 | -1.2      | V                |

**Notes :**

1. Pulse Test : pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
2. Switching characteristics are independent of operating junction temperatures.
3. These parameters have no way to verify.

# Typical Characteristics

CJ2101

